

## Final datasheet

## Short circuit rugged 1200 V TRENCHSTOP™ IGBT 7 technology

## Features

- $V_{CE} = 1200\text{ V}$
- $I_C = 25\text{ A}$
- Very low  $V_{CEsat} = 1.65\text{ V}$  (typ.) at  $I_{Cnom} = 25\text{ A}$ ,  $25^\circ\text{C}$
- Short circuit robust  $t_{sc} = 4\text{ }\mu\text{s}$  at  $V_{CE} = 800\text{ V}$ ,  $V_{GE} = 15\text{ V}$
- Smooth switching characteristics
- Wide range of  $dv/dt$  controllability
- TO263-7 package with high creepage distance  $> 5.8\text{ mm}$ ,  $400 \leq CTI < 600$
- High reliability and operating lifetime

## Potential applications

- xEV auxiliary drives
- Automotive HV heaters

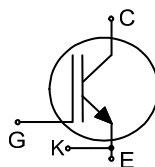
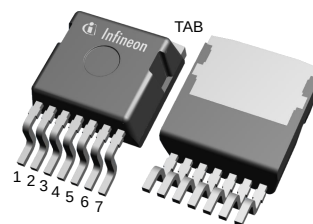
## Product validation

- Qualified according to AEC-Q101 for automotive applications
- Qualified Reflow device according to JEDEC J-STD-020 MSL1

## Description

Pin definition:

- Pin 1 - Gate
- Pin 2 - Kelvin Emitter
- Pin 3...7 - Emitter
- Tab - Collector



| Type          | Package        | Marking  |
|---------------|----------------|----------|
| AIGBG25N120S7 | PG-TO263-7-U01 | AGBG25S7 |



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## 1 Package

**Table 1** Characteristic values

| Parameter                              | Symbol        | Note or test condition                               | Values |      |      | Unit |
|----------------------------------------|---------------|------------------------------------------------------|--------|------|------|------|
|                                        |               |                                                      | Min.   | Typ. | Max. |      |
| Storage temperature                    | $T_{stg}$     |                                                      | -55    |      | 150  | °C   |
| Soldering temperature                  | $T_{sold}$    | reflow soldering (MSL1 according to JEDEC J-STD-020) |        |      | 260  | °C   |
| IGBT thermal resistance, junction-case | $R_{th(j-c)}$ |                                                      |        | 0.45 | 0.6  | K/W  |

## 2 IGBT

**Table 2** Maximum rated values

| Parameter                                              | Symbol       | Note or test condition                                                                                                                                                    |                       | Values   | Unit          |
|--------------------------------------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|----------|---------------|
| Collector-emitter voltage <sup>1)</sup>                | $V_{CE}$     | $T_{vj} = -40...175\text{ °C}$                                                                                                                                            |                       | 1200     | V             |
| DC collector current, limited by $T_{vjmax}$           | $I_C$        |                                                                                                                                                                           | $T_c = 25\text{ °C}$  | 55       | A             |
|                                                        |              |                                                                                                                                                                           | $T_c = 100\text{ °C}$ | 37       |               |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpulse}$ |                                                                                                                                                                           |                       | 75       | A             |
| Turn-off safe operating area                           |              | $V_{CE} \leq 1200\text{ V}$ , $t_p \leq 1\text{ }\mu\text{s}$ , $T_{vj} \leq 175\text{ °C}$                                                                               |                       | 75       | A             |
| Gate-emitter voltage                                   | $V_{GE}$     |                                                                                                                                                                           |                       | $\pm 20$ | V             |
| Transient gate-emitter voltage                         | $V_{GE}$     | $t_p \leq 0.5\text{ }\mu\text{s}$ , $D < 0.01$                                                                                                                            |                       | $\pm 25$ | V             |
| Short-circuit withstand time                           | $t_{SC}$     | $V_{CC} \leq 800\text{ V}$ , $V_{GE} = 15\text{ V}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}$ , $T_{vj} = 175\text{ °C}$ |                       | 4        | $\mu\text{s}$ |
| Power dissipation                                      | $P_{tot}$    |                                                                                                                                                                           | $T_c = 25\text{ °C}$  | 250      | W             |
|                                                        |              |                                                                                                                                                                           | $T_c = 100\text{ °C}$ | 125      |               |

1) Tested at  $T_{vj}=25\text{ °C}$ , verified by design/characterization over full temperature range

**Table 3** Characteristic values

| Parameter                            | Symbol      | Note or test condition                       | Values |                          |      | Unit |
|--------------------------------------|-------------|----------------------------------------------|--------|--------------------------|------|------|
|                                      |             |                                              | Min.   | Typ.                     | Max. |      |
| Collector-emitter saturation voltage | $V_{CEsat}$ | $I_C = 25\text{ A}$ , $V_{GE} = 15\text{ V}$ |        | $T_{vj} = 25\text{ °C}$  | 1.65 | V    |
|                                      |             |                                              |        | $T_{vj} = 175\text{ °C}$ | 2    |      |
| Gate-emitter threshold voltage       | $V_{GEth}$  | $I_C = 0.49\text{ mA}$ , $V_{CE} = V_{GE}$   | 5.15   | 5.7                      | 6.45 | V    |

(table continues...)

**Table 3 (continued) Characteristic values**

| Parameter                           | Symbol       | Note or test condition                                                                                                                                                            |                                               | Values |       |      | Unit          |
|-------------------------------------|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------|--------|-------|------|---------------|
|                                     |              |                                                                                                                                                                                   |                                               | Min.   | Typ.  | Max. |               |
| Zero gate-voltage collector current | $I_{CES}$    | $V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}$                                                                                                                                   | $T_{vj} = 25 \text{ °C}$                      |        |       | 40   | $\mu\text{A}$ |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}$                     |        | 2000  |      |               |
| Gate-emitter leakage current        | $I_{GES}$    | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$                                                                                                                                     |                                               |        |       | 100  | nA            |
| Transconductance                    | $g_{fs}$     | $I_C = 25 \text{ A}, V_{CE} = 20 \text{ V}, T_{vj} = 175 \text{ °C}$                                                                                                              |                                               |        | 9.3   |      | S             |
| Short-circuit collector current     | $I_{SC}$     | $V_{CC} \leq 800 \text{ V}, V_{GE} = 15 \text{ V}, t_{SC} \leq 4 \text{ }\mu\text{s}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0 \text{ s}$ | $T_{vj} = 25 \text{ °C}$                      |        | 158.2 |      | A             |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}$                     |        | 126.5 |      |               |
| Input capacitance                   | $C_{ies}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$                                                                                                                |                                               |        | 3.6   |      | nF            |
| Output capacitance                  | $C_{oes}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$                                                                                                                |                                               |        | 58    |      | pF            |
| Reverse transfer capacitance        | $C_{res}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$                                                                                                                |                                               |        | 17    |      | pF            |
| Gate charge                         | $Q_G$        | $V_{CC} = 960 \text{ V}, I_C = 25 \text{ A}, V_{GE} = 0/15 \text{ V}$                                                                                                             |                                               |        | 158   |      | nC            |
| Turn-on delay time                  | $t_{d(on)}$  | $V_{CC} = 800 \text{ V}, V_{GE} = 15 \text{ V}, R_{G(on)} = 4.5 \text{ }\Omega, R_{G(off)} = 4.5 \text{ }\Omega$                                                                  | $T_{vj} = 25 \text{ °C}, I_C = 25 \text{ A}$  |        | 12.9  |      | ns            |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}, I_C = 25 \text{ A}$ |        | 14.5  |      |               |
| Rise time (inductive load)          | $t_r$        | $V_{CC} = 800 \text{ V}, V_{GE} = 15 \text{ V}, R_{G(on)} = 4.5 \text{ }\Omega, R_{G(off)} = 4.5 \text{ }\Omega$                                                                  | $T_{vj} = 25 \text{ °C}, I_C = 25 \text{ A}$  |        | 4.5   |      | ns            |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}, I_C = 25 \text{ A}$ |        | 5.8   |      |               |
| Turn-off delay time                 | $t_{d(off)}$ | $V_{CC} = 800 \text{ V}, V_{GE} = 15 \text{ V}, R_{G(on)} = 4.5 \text{ }\Omega, R_{G(off)} = 4.5 \text{ }\Omega$                                                                  | $T_{vj} = 25 \text{ °C}, I_C = 25 \text{ A}$  |        | 120   |      | ns            |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}, I_C = 25 \text{ A}$ |        | 186   |      |               |
| Fall time (inductive load)          | $t_f$        | $V_{CC} = 800 \text{ V}, V_{GE} = 15 \text{ V}, R_{G(on)} = 4.5 \text{ }\Omega, R_{G(off)} = 4.5 \text{ }\Omega$                                                                  | $T_{vj} = 25 \text{ °C}, I_C = 25 \text{ A}$  |        | 86    |      | ns            |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}, I_C = 25 \text{ A}$ |        | 165   |      |               |
| Turn-on energy                      | $E_{on}$     | $V_{CC} = 800 \text{ V}, V_{GE} = 15 \text{ V}, R_{G(on)} = 4.5 \text{ }\Omega, R_{G(off)} = 4.5 \text{ }\Omega$                                                                  | $T_{vj} = 25 \text{ °C}, I_C = 25 \text{ A}$  |        | 0.2   |      | mJ            |
|                                     |              |                                                                                                                                                                                   | $T_{vj} = 175 \text{ °C}, I_C = 25 \text{ A}$ |        | 0.3   |      |               |

**(table continues...)**

**Table 3** (continued) Characteristic values

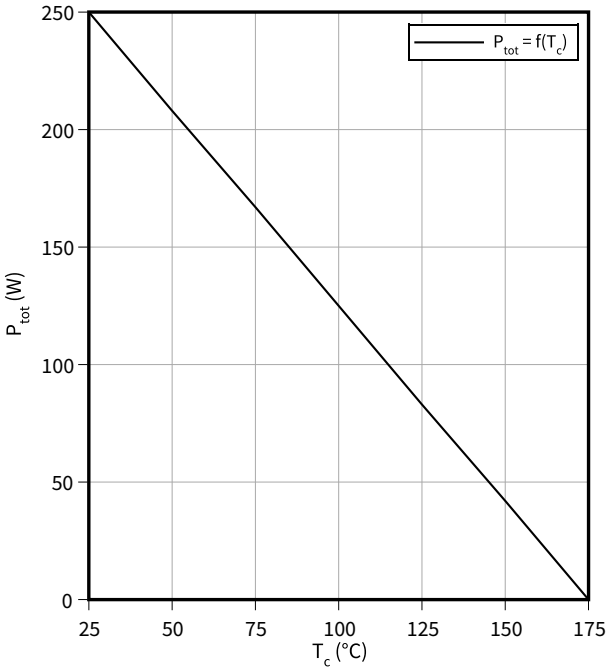
| Parameter                      | Symbol    | Note or test condition                                                                                          |                                                                   | Values |      |      | Unit               |
|--------------------------------|-----------|-----------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|--------|------|------|--------------------|
|                                |           |                                                                                                                 |                                                                   | Min.   | Typ. | Max. |                    |
| Turn-off energy                | $E_{off}$ | $V_{CC} = 800 \text{ V}$ , $V_{GE} = 15 \text{ V}$ ,<br>$R_{G(on)} = 4.5 \Omega$ ,<br>$R_{G(off)} = 4.5 \Omega$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 25 \text{ A}$  |        | 1.47 |      | mJ                 |
|                                |           |                                                                                                                 | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 25 \text{ A}$ |        | 2.61 |      |                    |
| Total switching energy         | $E_{ts}$  | $V_{CC} = 800 \text{ V}$ , $V_{GE} = 15 \text{ V}$ ,<br>$R_{G(on)} = 4.5 \Omega$ ,<br>$R_{G(off)} = 4.5 \Omega$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 25 \text{ A}$  |        | 1.67 |      | mJ                 |
|                                |           |                                                                                                                 | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 25 \text{ A}$ |        | 2.91 |      |                    |
| Operating junction temperature | $T_{vj}$  |                                                                                                                 |                                                                   | -40    |      | 175  | $^{\circ}\text{C}$ |

**Note:** Electrical Characteristic at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified.

### 3 Characteristics diagrams

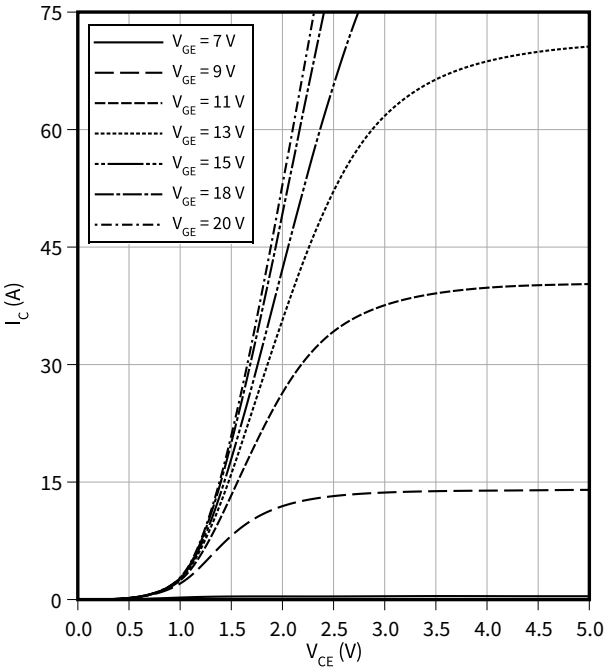
#### Power dissipation as a function of case temperature

$P_{\text{tot}} = f(T_c)$   
 $T_{vj} \leq 175\text{ °C}$



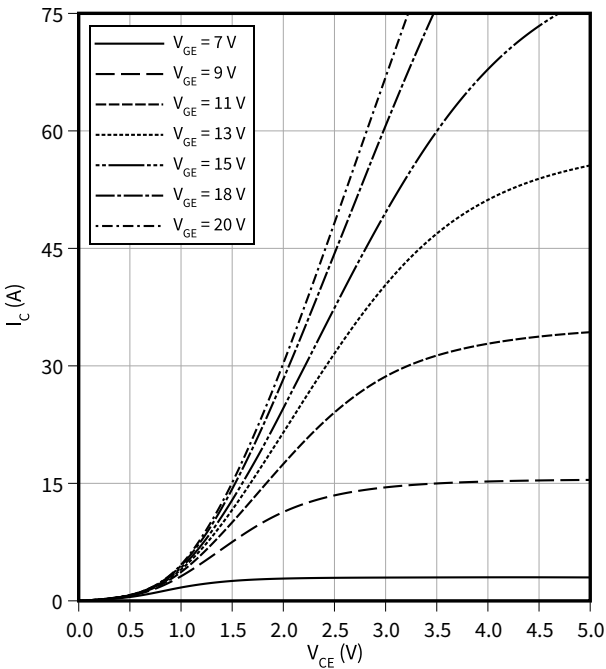
#### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 25\text{ °C}$



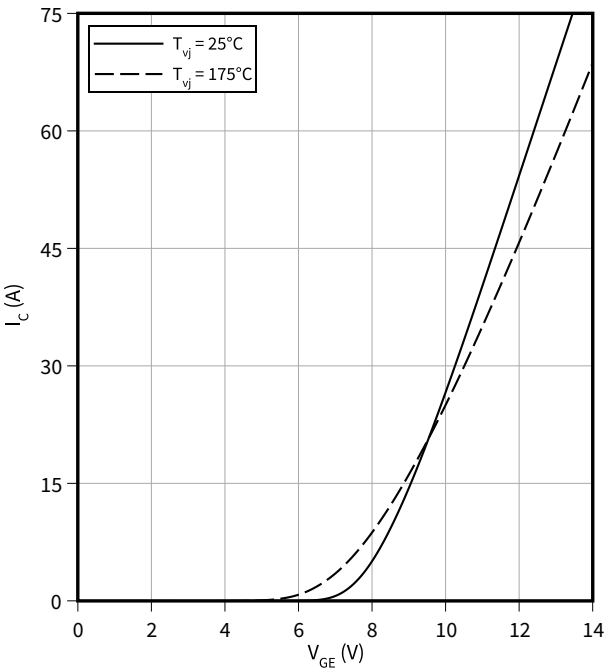
#### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$



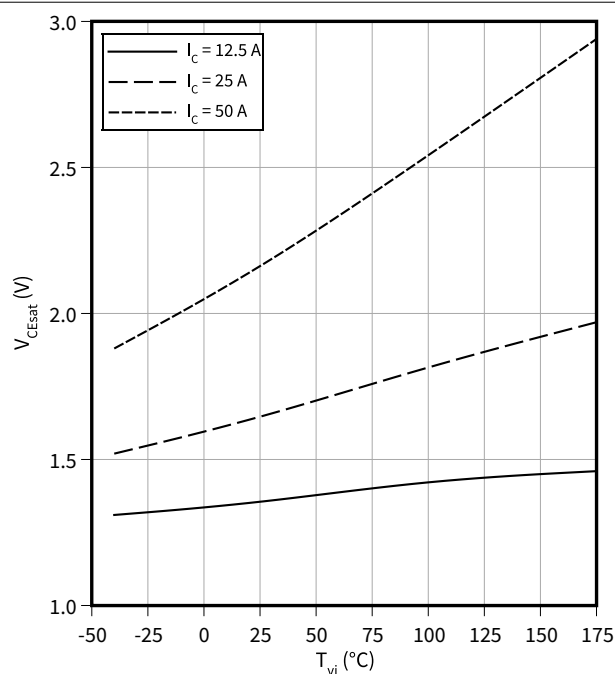
#### Typical transfer characteristic

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



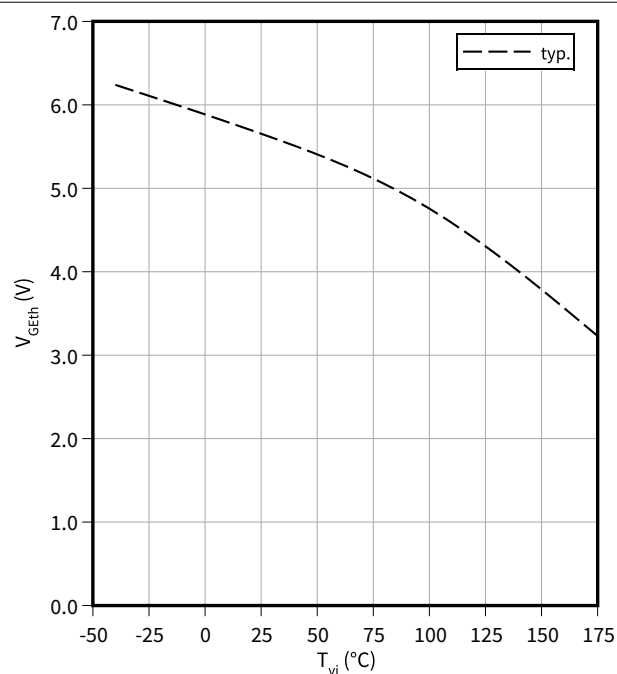
**3 Characteristics diagrams**
**Typical collector-emitter saturation voltage as a function of junction temperature**

$$V_{CEsat} = f(T_{vj})$$


**Gate-emitter threshold voltage as a function of junction temperature**

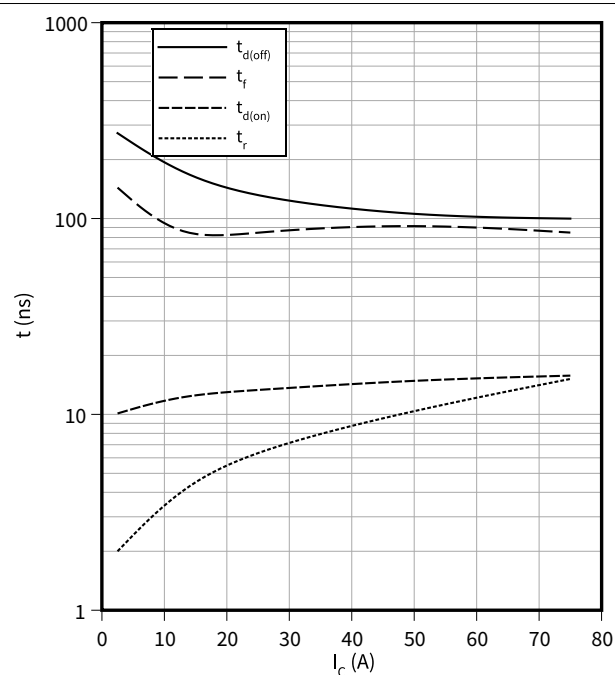
$$V_{GEth} = f(T_{vj})$$

$$I_C = 0.85 \text{ mA}$$


**Typical switching times as a function of collector current**

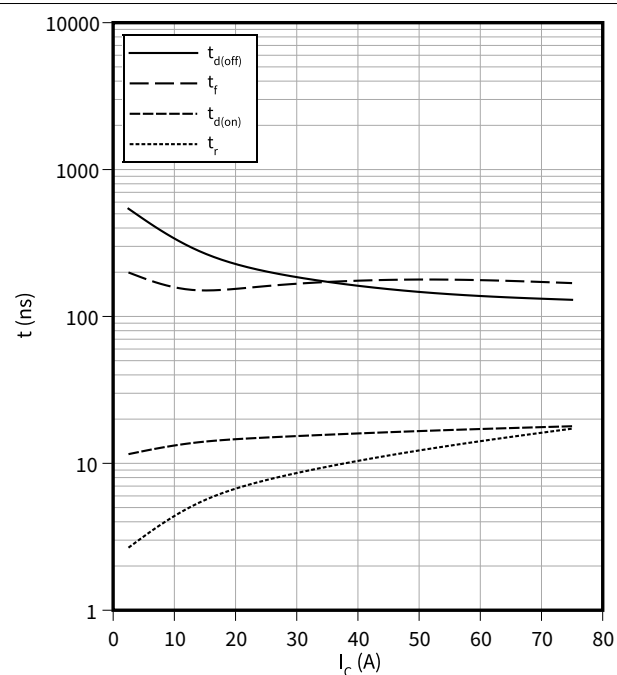
$$t = f(I_C)$$

$$V_{CC} = 800 \text{ V}, T_{vj} = 25 \text{ °C}, R_G = 4.5 \text{ } \Omega$$


**Typical switching times as a function of collector current**

$$t = f(I_C)$$

$$V_{CC} = 800 \text{ V}, T_{vj} \geq 25 \text{ °C}, R_G = 4.5 \text{ } \Omega$$

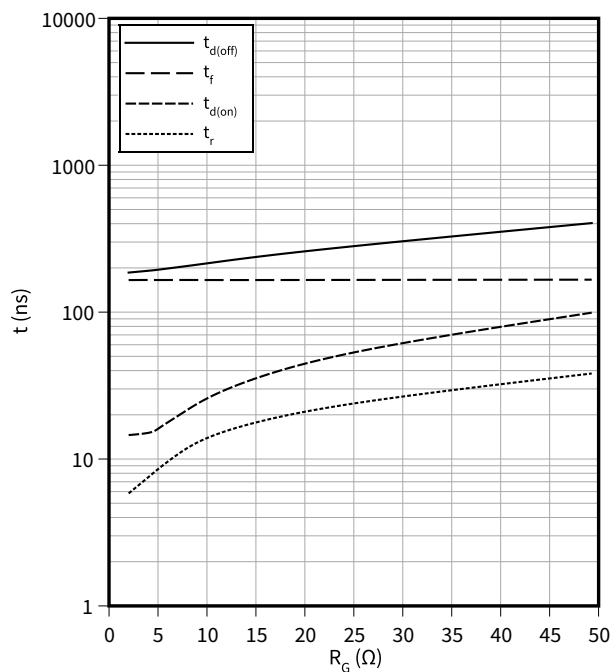


3 Characteristics diagrams

**Typical switching times as a function of gate resistor**

$t = f(R_G)$

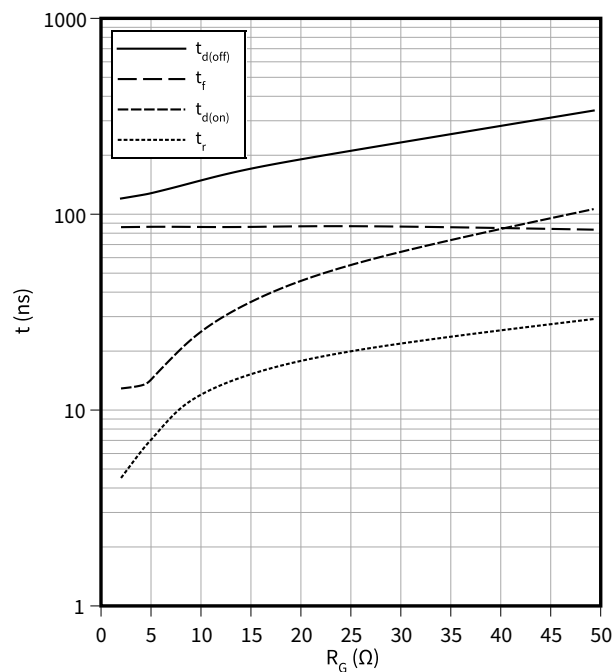
$I_C = 25 \text{ A}$ ,  $V_{CC} = 800 \text{ V}$ ,  $T_{vj} = 175 \text{ °C}$



**Typical switching times as a function of gate resistor**

$t = f(R_G)$

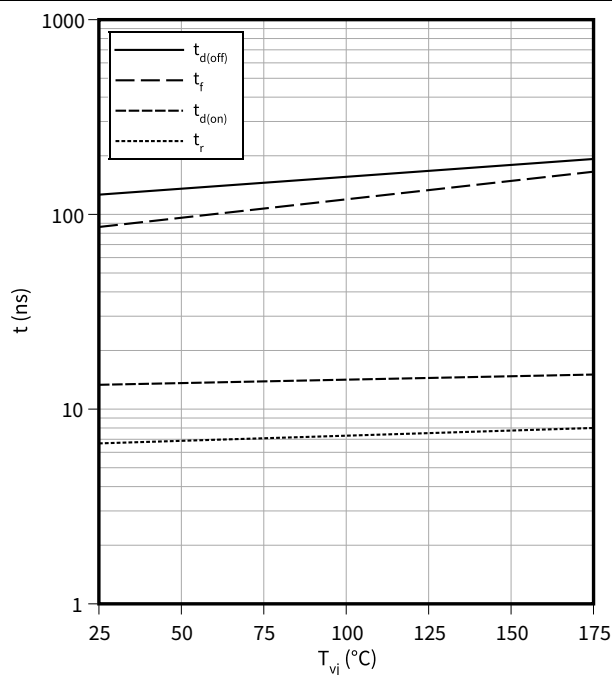
$I_C = 25 \text{ A}$ ,  $V_{CC} = 800 \text{ V}$ ,  $T_{vj} = 25 \text{ °C}$



**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

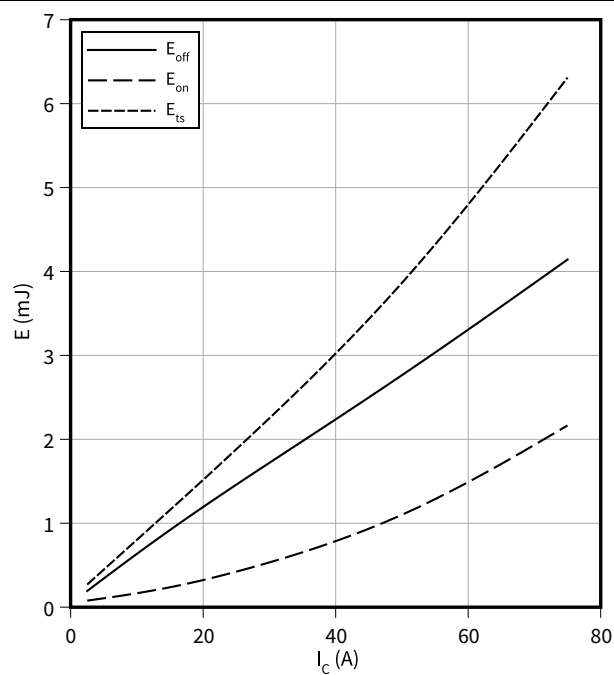
$I_C = 25 \text{ A}$ ,  $V_{CC} = 800 \text{ V}$ ,  $R_G = 4.5 \text{ }\Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

$V_{CC} = 800 \text{ V}$ ,  $T_{vj} = 25 \text{ °C}$ ,  $R_G = 4.5 \text{ }\Omega$



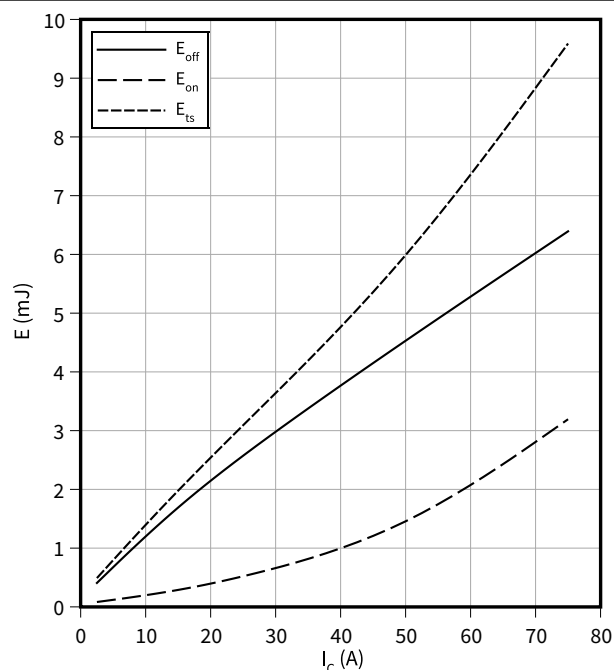


3 Characteristics diagrams

**Typical switching energy losses as a function of collector current**

$$E = f(I_C)$$

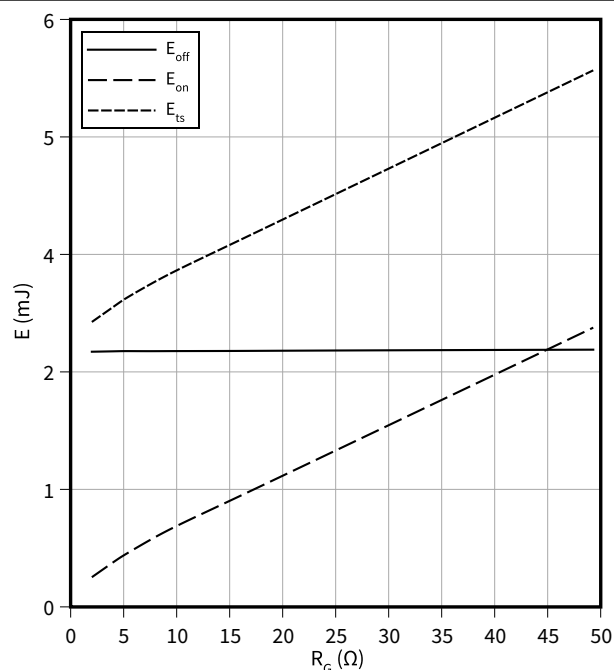
$V_{CC} = 800 \text{ V}$ ,  $T_{vj} \geq 25 \text{ °C}$ ,  $R_G = 4.5 \text{ } \Omega$



**Typical switching energy losses as a function of gate resistor**

$$E = f(R_G)$$

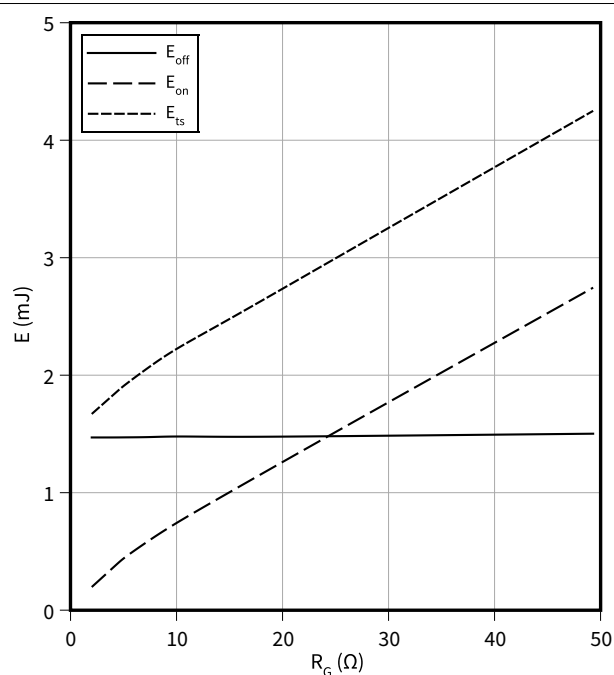
$I_C = 25 \text{ A}$ ,  $V_{CC} = 800 \text{ V}$ ,  $T_{vj} = 175 \text{ °C}$



**Typical switching energy losses as a function of gate resistor**

$$E = f(R_G)$$

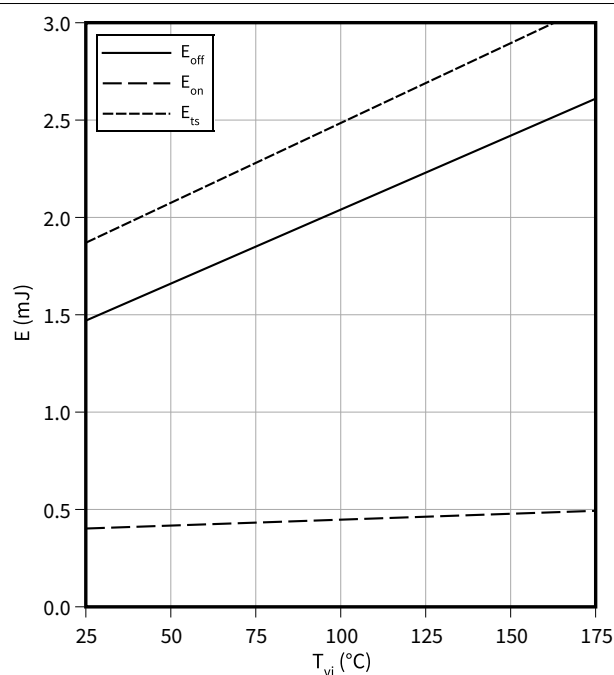
$I_C = 25 \text{ A}$ ,  $V_{CC} = 800 \text{ V}$ ,  $T_{vj} = 25 \text{ °C}$



**Typical switching energy losses as a function of junction temperature**

$$E = f(T_{vj})$$

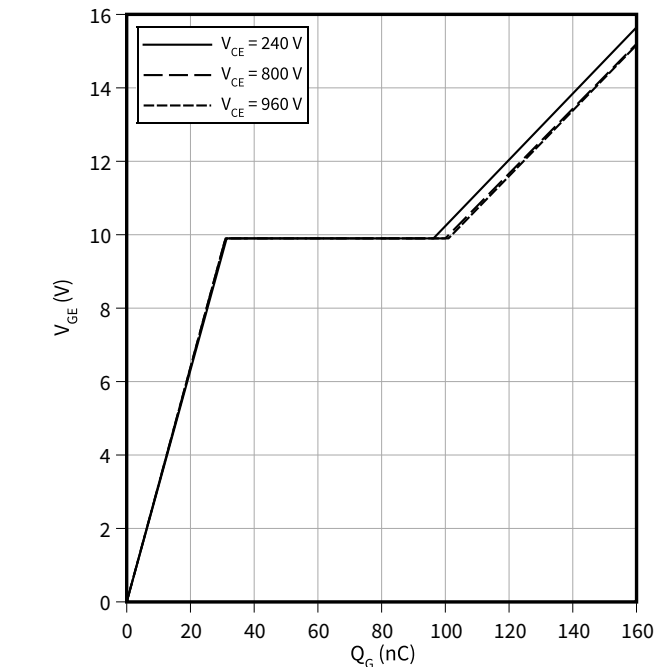
$I_C = 25 \text{ A}$ ,  $V_{CC} = 800 \text{ V}$ ,  $R_G = 4.5 \text{ } \Omega$



3 Characteristics diagrams

Typical gate charge

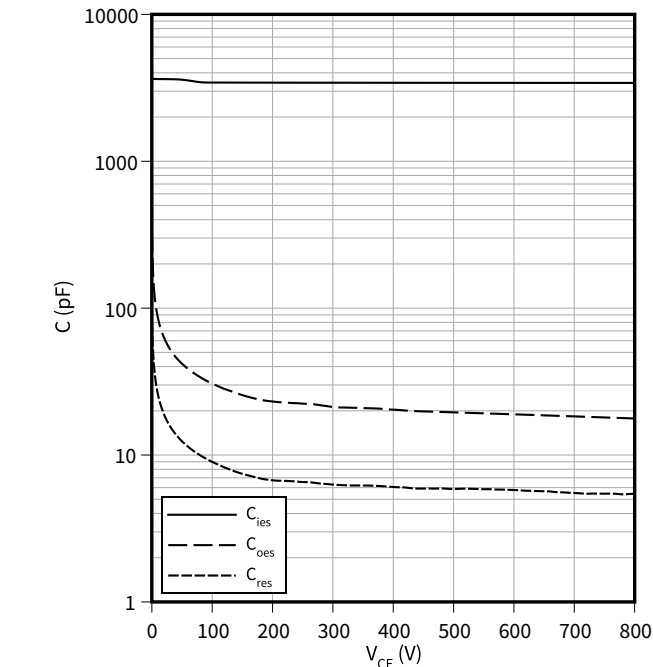
$V_{GE} = f(Q_G)$



Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$

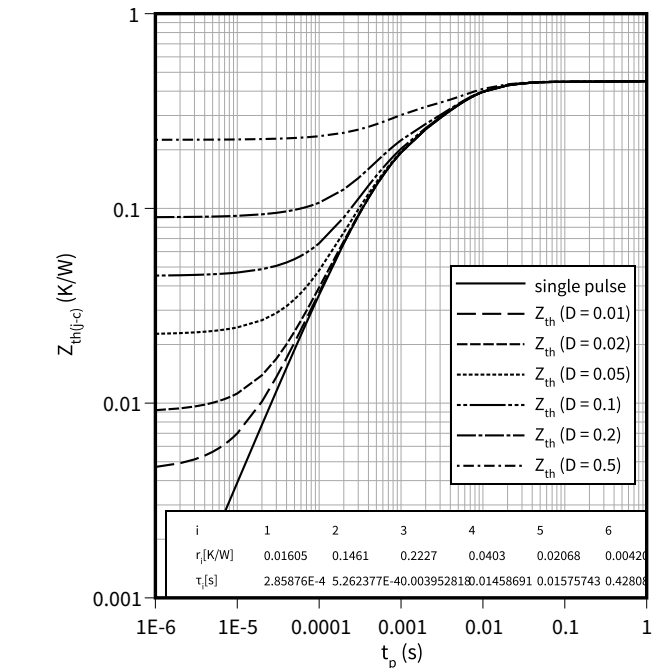
$f = 100$  kHz,  $V_{GE} = 0$  V



IGBT typical transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$

$D = t_p/T$



4 Package outlines

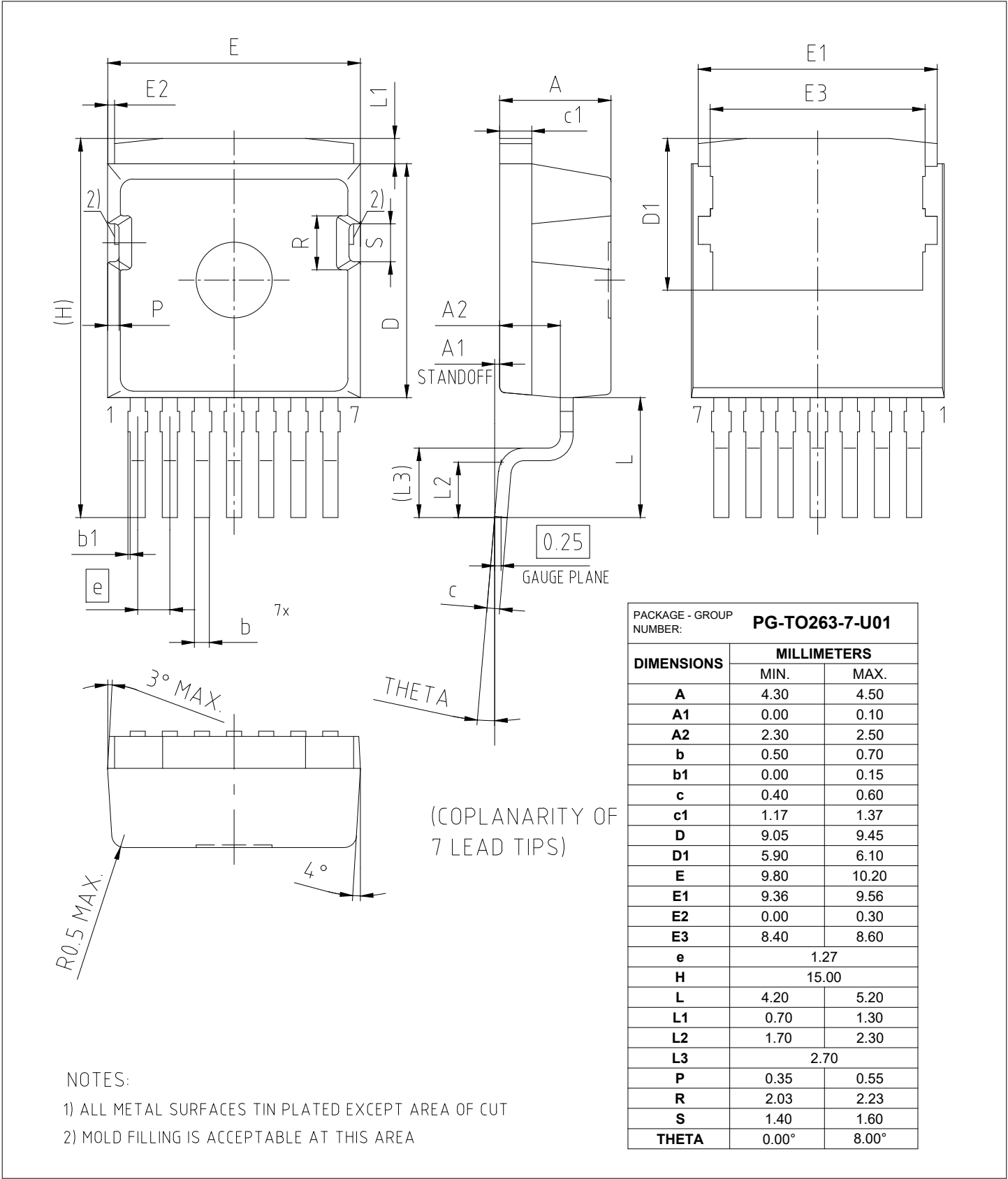


Figure 1

## 5 Testing conditions

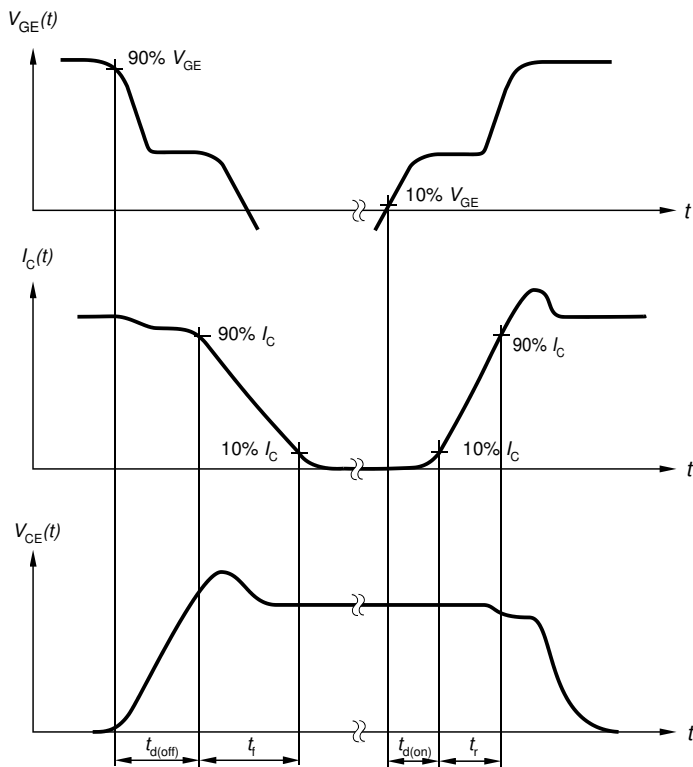


Figure A. Definition of switching times

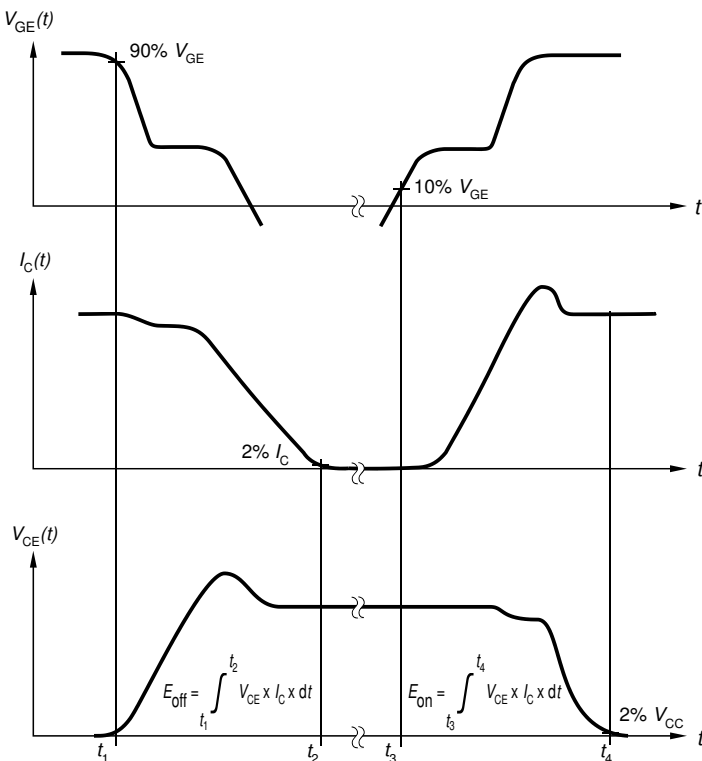


Figure B. Definition of switching losses

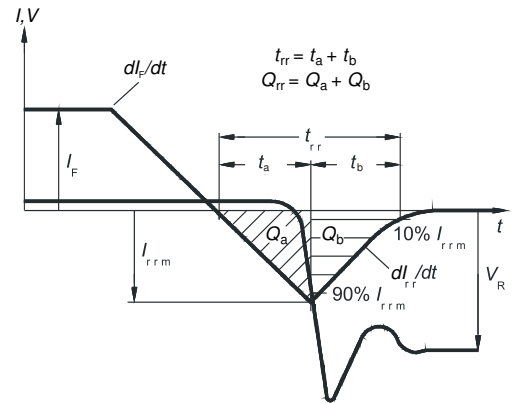


Figure C. Definition of diode switching characteristics

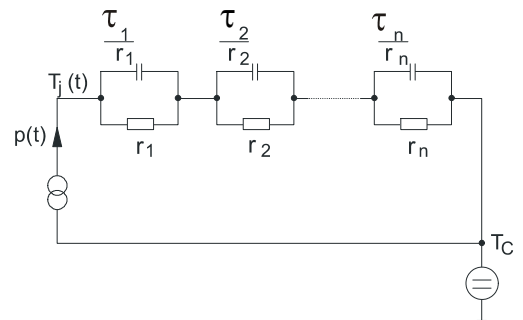


Figure D. Thermal equivalent circuit

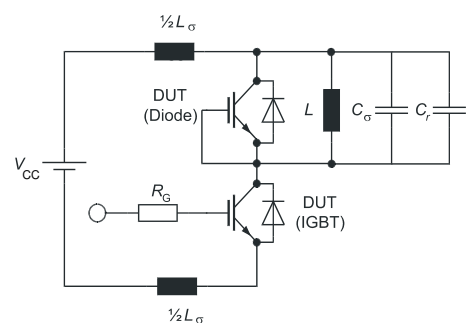


Figure E. **Dynamic test circuit**  
 Parasitic inductance  $L_\sigma$ ,  
 parasitic capacitor  $C_\sigma$ ,  
 relief capacitor  $C_r$ ,  
 (only for ZVT switching)



**Revision history**

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10              | 2024-03-14      | Target datasheet       |
| 0.20              | 2025-04-29      | Preliminary datasheet  |
| 1.00              | 2025-09-18      | Final datasheet        |

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**IFX-ABJ814-003**

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